

20V, 90A
N-CHANNEL POWER MOSFET

■ **Features**

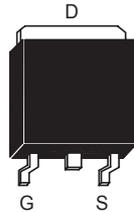
$R_{DS(ON)} < 4.0m\Omega @ V_{GS}=4.5V$
 $R_{DS(ON)} < 6.0m\Omega @ V_{GS}=2.5V$
 Advanced Trench Technology
 Provide Excellent $R_{DS(ON)}$ and Low Gate Charge
 Lead free product is acquired

■ **Application**
 Load Switch
 PWM Application
 Power management

100% UIS TESTED !
100% ΔV_{ds} TESTED !

Product Summary

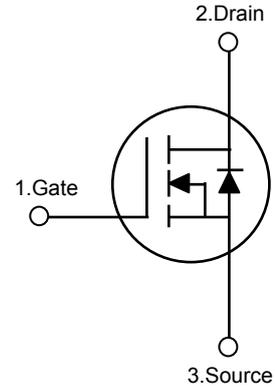
V_{DS}	20	V
$R_{DS(ON)}$	4	m Ω
I_D	90	A



TO-252



Marking



ORDERING INFORMATION

Order Number	Package	Pin Assignment			Packing	Reel Size	Reel	Per Carton
		1	2	3			Pcs	Pcs
HPD032N02STA	TO-252	G	D	S	Tape Reel	13 Inch	2500	25000

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise specified)

Symbol	Parameter	Max.	Units
V_{DSS}	Drain-Source Voltage	20	V
V_{GSS}	Gate-Source Voltage	± 12	
I_D	Continuous Drain Current	$T_C=25^\circ C$	90
		$T_C=100^\circ C$	59
I_{DM}	Pulsed Drain Current ^{note1}	360	A
E_{AS}	Single Pulsed Avalanche Energy ^{note2}	110	mJ
P_D	Power Dissipation	$T_C=25^\circ C$	81
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.85	$^\circ C/W$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	$^\circ C$

Electrical Characteristics (T_C=25°C, unless otherwise specified)**Off Characteristic**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	20	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±12V	--	--	±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.4	0.7	1	V
R _{DS(on)}	Static Drain-Source on-Resistance (note3)	V _{GS} =4.5V, I _D =30A	--	2.8	4	mΩ
		V _{GS} =2.5V, I _D =20A	--	4	6	

Dynamic Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
C _{iss}	Input Capacitance	V _{DS} =10V V _{GS} =0V f=1.0MHz	--	3200	--	pF
C _{oss}	Output Capacitance		--	460	--	
C _{rss}	Reverse Transfer Capacitance		--	445	--	
Q _g	Total Gate Charge	V _{DS} =10V I _D =30A V _{GS} =4.5V R _G =1.8Ω	--	48	--	nC
Q _{gs}	Gate-Source Charge		--	3.6	--	
Q _{gd}	Gate-Drain("Miller") Charge		--	19	--	

Electrical Characteristics ($T_C=25^\circ\text{C}$, unless otherwise specified)**Switching Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=10V$ $I_D=30A$ $R_{GEN}=1.8\Omega$ $V_{GS}=4.5V$	--	9.7	--	nS
t_r	Turn-on Rise Time		--	37	--	
$t_{d(off)}$	Turn-off Delay Time		--	63	--	
t_f	Turn-off Fall Time		--	52	--	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Maximum Continuous Drain to Source Diode Forward Current		--	--	90	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		--	--	360	
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S=30A$	--	--	1.2	V
t_{rr}	Body Diode Reverse Recovery Time	$I_F=20A$ $di/dt=100A/\mu s$	--	23	--	nS
Q_{rr}	Body Diode Reverse Recovery Charge		--	10	--	nC

Notes:

- 1、Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- 2、EAS condition : $T_J=25^\circ\text{C}$, $V_{DD}=15V$, $V_G=4.5V$, $R_G=25\Omega$, $L=0.5mH$, $I_{AS}=21A$
- 3、Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 0.5\%$



Typical Performance Characteristics

Figure1: Output Characteristics

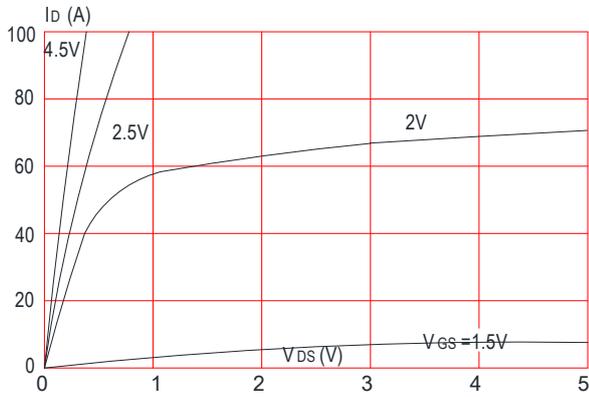


Figure2: Typical Transfer Characteristics

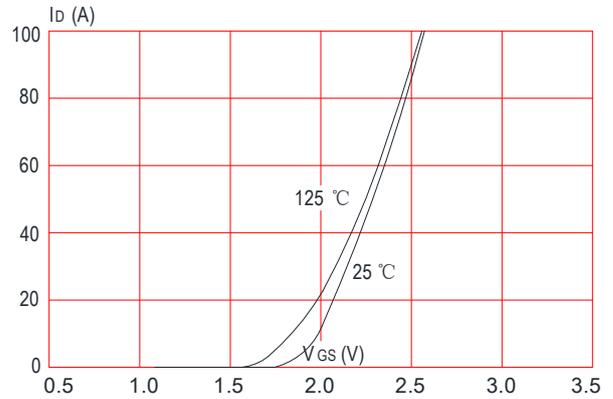


Figure3: On-resistance vs. Drain Current

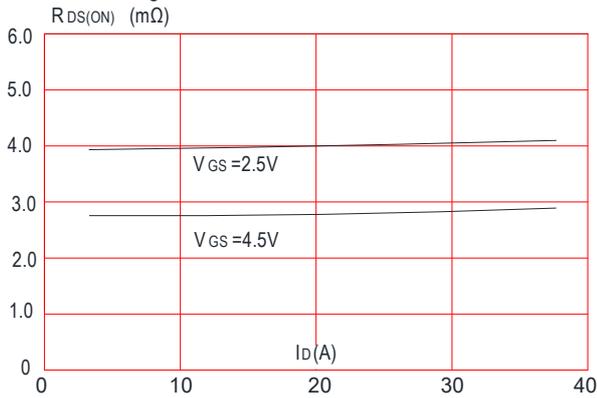


Figure4: Body Diode Characteristics

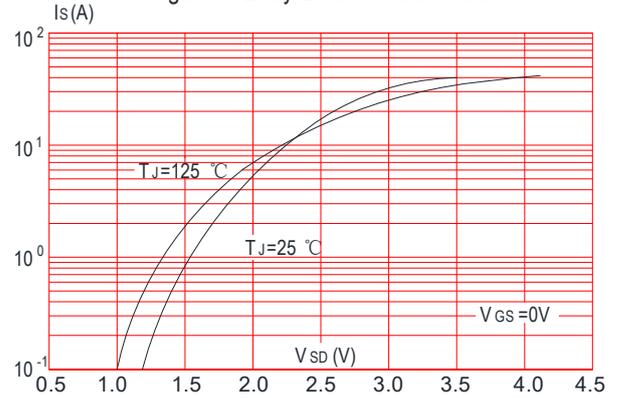


Figure5: Gate Charge Characteristics

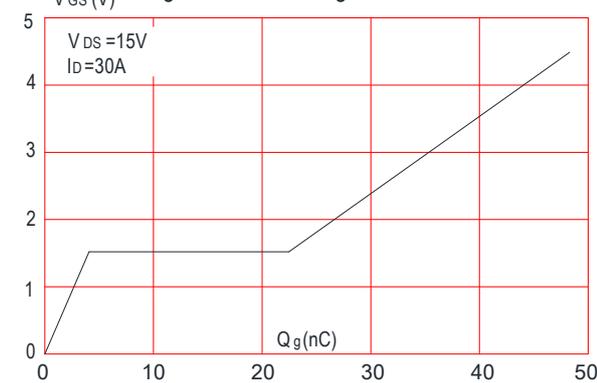


Figure6: Capacitance Characteristics

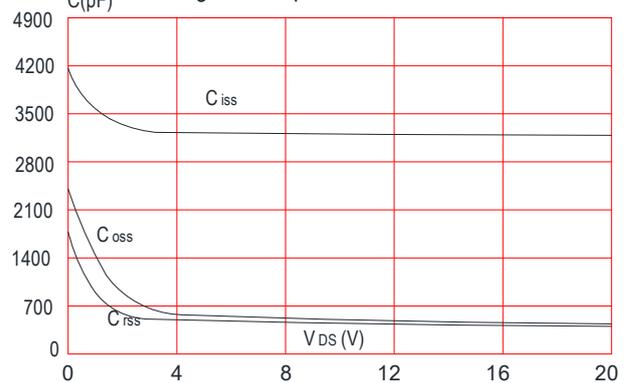


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

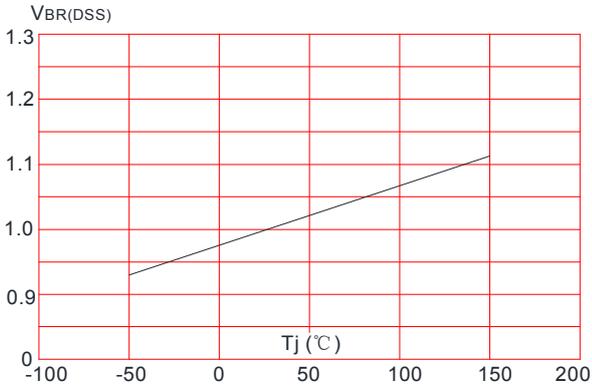


Figure 8: Normalized on Resistance vs. Junction Temperature

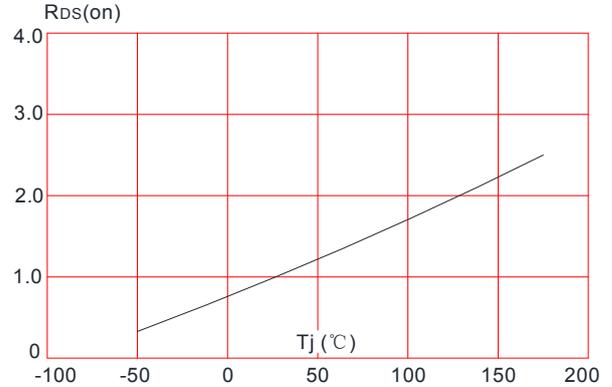


Figure 9: Maximum Safe Operating Area

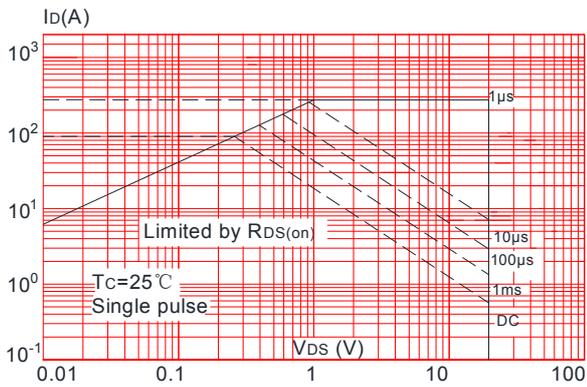


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

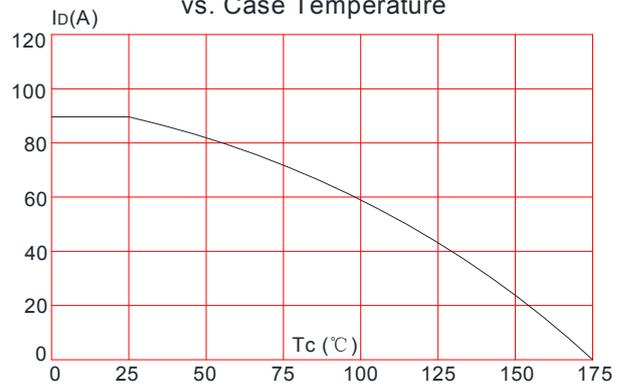
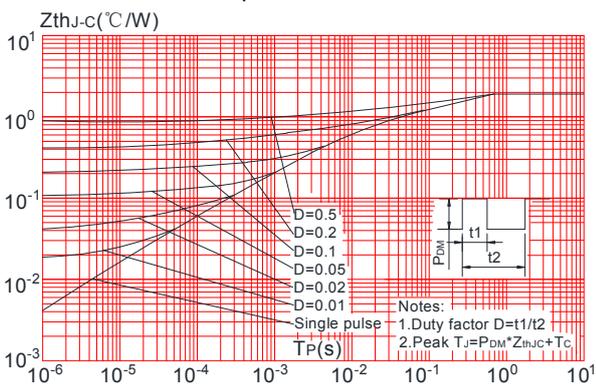


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case





Test Circuit

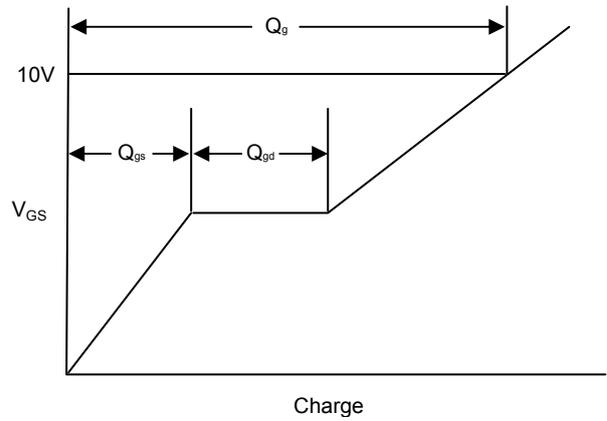
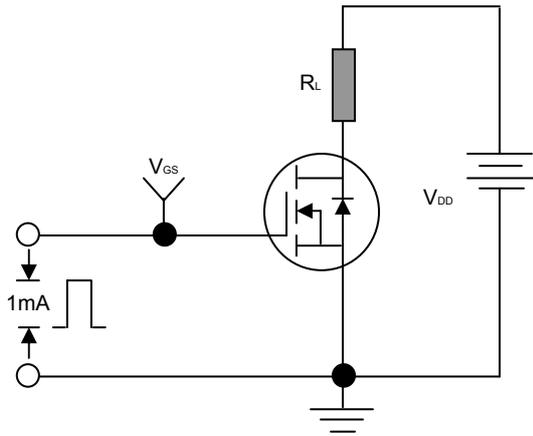


Fig-1: Gate Charge Test Circuit & Waveform

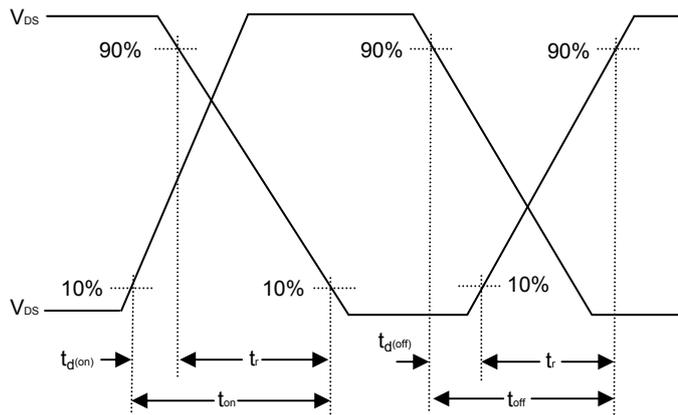
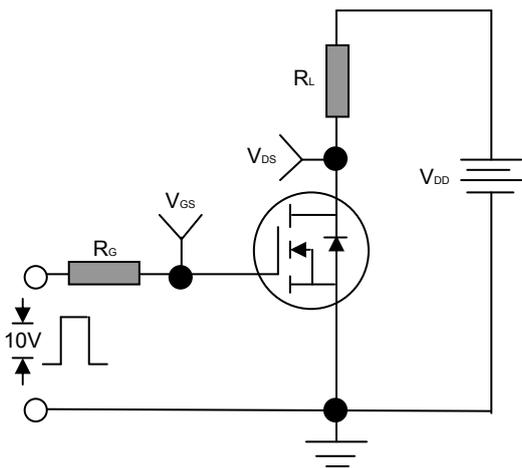


Fig-2: Resistive Switching Test Circuit & Waveforms

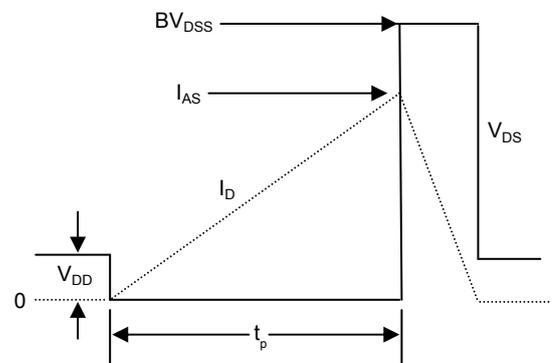
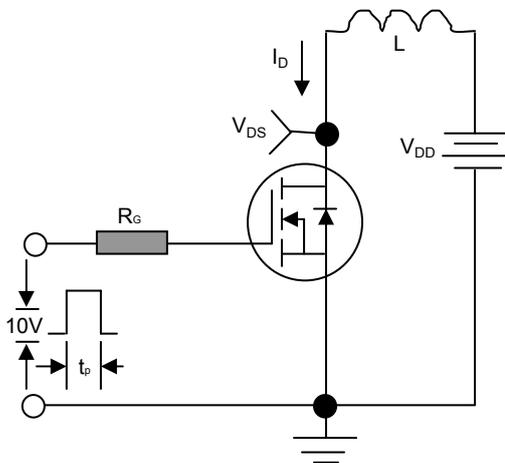
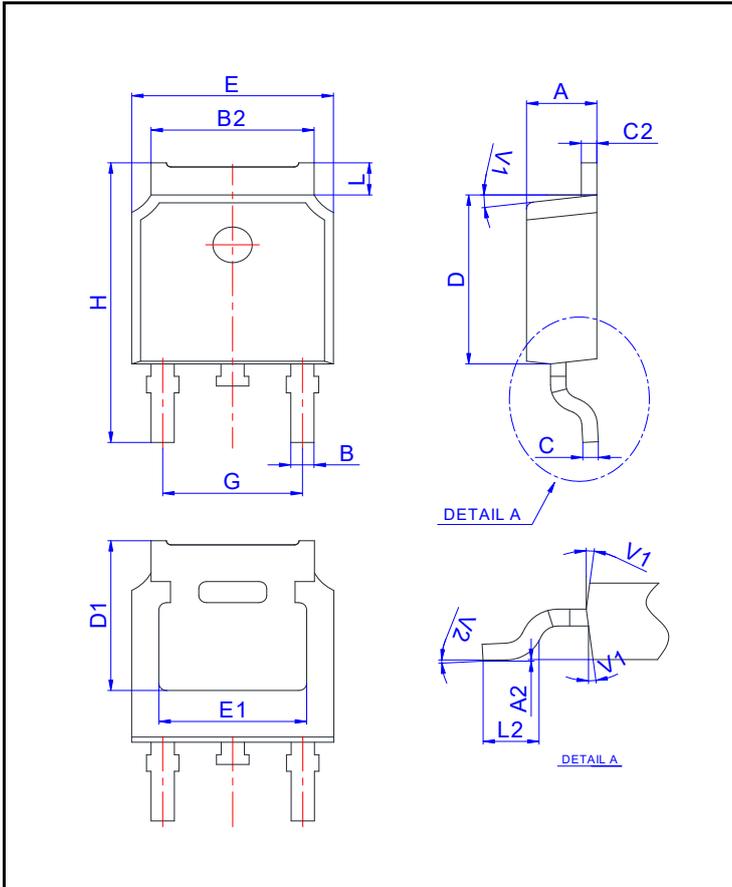


Fig-3: Unclamped Inductive Switching Test Circuit & Waveforms

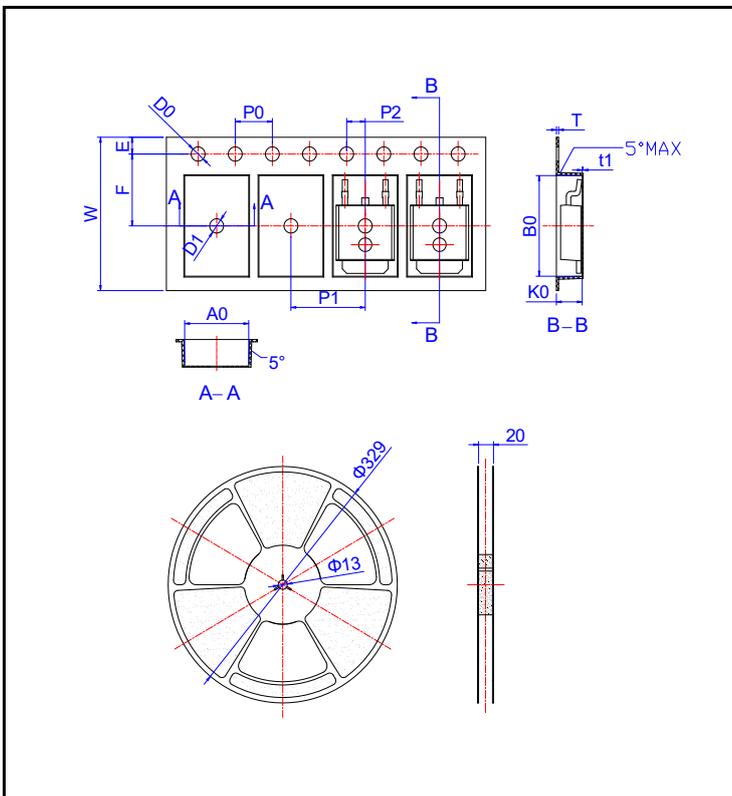


TO-252 (DPAK) PACKAGE MECHANICAL DATA (mm & inch)



REF.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.10	2.50	0.083	0.098
A2	0	0.10	0	0.004
B	0.66	0.86	0.026	0.034
B2	5.18	5.48	0.202	0.216
C	0.40	0.60	0.016	0.024
C2	0.44	0.58	0.017	0.023
D	5.90	6.30	0.232	0.248
D1	5.30 REF		0.209 REF	
E	6.40	6.80	0.252	0.268
E1	4.63		0.182	
G	4.47	4.67	0.176	0.184
H	9.50	10.7	0.374	0.421
L	1.09	1.21	0.043	0.048
L2	1.35	1.65	0.053	0.065
V1	7° TYP.		7° TYP.	
V2	0°	6°	0°	6°

TO-252 Reel Specification



REF.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
W	15.90	16.10	0.626	0.634
E	1.65	1.85	0.065	0.073
F	7.40	7.60	0.291	0.299
D0	1.40	1.60	0.055	0.063
D1	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
P1	7.90	8.10	0.311	0.319
P2	1.90	2.10	0.075	0.083
A0	6.85	7.00	0.270	0.276
B0	10.45	10.60	0.411	0.417
K0	2.63	2.88	0.105	0.113
T	0.24	0.27	0.009	0.011
t1	0.10		0.004	
10P0	39.80	40.20	1.567	1.583



Manufacturers version information
2020-07-13 . HAOHAI™ Product Data-1.0
2021-08-19 . HAOHAI™ Product Data-1.1



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